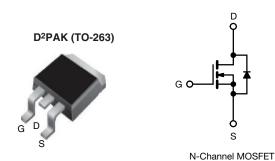


E Series Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V) at T _J max. 650				
R _{DS(on)} max. (Ω) at 25 °C	V _{GS} = 10 V	0.125		
Q _g max. (nC)	130			
Q _{gs} (nC)	15			
Q _{gd} (nC)	39			
Configuration	Single			

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (C_{iss})
- · Reduced switching and conduction losses
- Ultra low gate charge (Qa)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
 - LED lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
- · Battery chargers
- · Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION			
Package	D ² PAK (TO-263)		
	SiHB30N60E-GE3		
Lead (Pb)-free and halogen-free	SiHB30N60ET1-GE3		
	SiHB30N60ET5-GE3		

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V_{DS}	600	.,	
Gate-source voltage			V_{GS}	± 30	V	
0 11 17 150 00		T _C = 25 °C		29		
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 v	$T_C = 25 \degree C$ $T_C = 100 \degree C$	ID	18	Α	
Pulsed drain current ^a			I _{DM}	76		
Linear derating factor				2	W/°C	
Single pulse avalanche energy b			E _{AS}	690	mJ	
Maximum power dissipation			P _D	250	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope $V_{DS} = 0 \text{ V to } 80 \text{ % } V_{DS}$		d\//d+	70	V/ns		
Reverse diode dV/dt ^d			dV/dt			18
Soldering recommendations (peak temperature) c for 10 s				300	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. $V_{DD} = 50 \text{ V}$, starting $T_J = 25 \,^{\circ}\text{C}$, $L = 28.2 \,^{\circ}\text{mH}$, $R_q = 25 \,^{\circ}\Omega$, $I_{AS} = 7 \,^{\circ}\text{A}$
- c. 1.6 mm from case
- d. $I_{SD} \le I_D$, $dI/dt = 100 \text{ A/}\mu\text{s}$, starting $T_J = 25 \,^{\circ}\text{C}$



Vishay Siliconix

THERMAL RESISTANCE RATINGS						
PARAMETER SYMBOL TYP. MAX. UNIT						
Maximum junction-to-ambient	R _{thJA}	-	62	°C/W		
Maximum junction-to-case (drain)	R_{thJC}	-	0.5	G/VV		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		-					
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$		600	-	-	٧
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I _D = 250 μA	-	0.64	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2	2.8	4	V
		V _{GS} = ± 20 V		-	-	± 100	nA
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μA
7		V _{DS} =	$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$		-	1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 600 \	/, V _{GS} = 0 V, T _J = 150 °C	-	-	100	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 15 A	-	0.104	0.125	Ω
Forward transconductance	9 _{fs}	V _D	_S = 8 V, I _D = 3 A	-	5.4	-	S
Dynamic							•
Input capacitance	C _{iss}		$V_{GS} = 0 V$,	-	2600	-	
Output capacitance	C _{oss}	1	$V_{DS} = 100 \text{ V},$	-	138	-	
Reverse transfer capacitance	C _{rss}	V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	3	-	pF
Effective output capacitance, energy related ^a	$C_{o(er)}$			-	98	-	
Effective output capacitance, time related ^b	C _{o(tr)}			-	346	-	
Total gate charge	Qg				85	130	
Gate-source charge	Q _{gs}	V _{GS} = 10 V I _D = 15 A, V _{DS} = 480 V		-	15	-	nC
Gate-drain charge	Q _{gd}			-	39	-	
Turn-on delay time	t _{d(on)}	V _{DD} = 380 V, I _D = 15 A,		-	19	40	ns
Rise time	t _r			-	32	65	
Turn-off delay time	t _{d(off)}		$V_{DD} = 360 \text{ V}, I_D = 15 \text{ A},$ $V_{GS} = 10 \text{ V}, R_g = 4.7 \Omega$		63	95	
Fall time	t _f				36	75	
Gate input resistance	R_g	f = 1 MHz, open drain		-	0.63	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	29	
Pulsed diode forward current	I _{SM}			-	-	65	A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 15 A, V _{GS} = 0 V		-	-	1.3	V
Body diode reverse recovery time	t _{rr}	0 1 1, 0 11, 100		-	402	605	ns
Body diode reverse recovery charge	Q _{rr}	T _J = 25 °C, I _F = I _S = 15 A,		-	7	15	μC
Reverse recovery current	I _{RRM}	dl/dt = 100 A/μs, V _R = 20 V		-	32	65	Α

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}
- b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

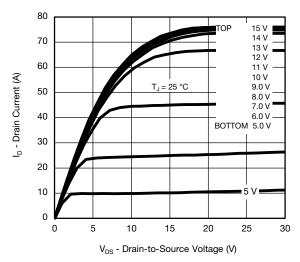


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

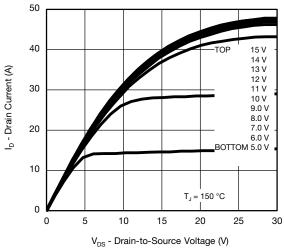


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

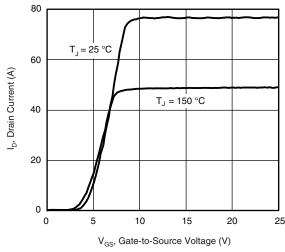


Fig. 3 - Typical Transfer Characteristics

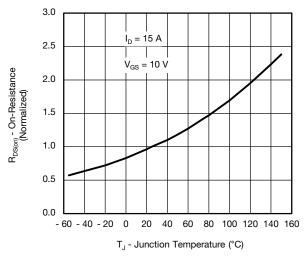


Fig. 4 - Normalized On-Resistance vs. Temperature

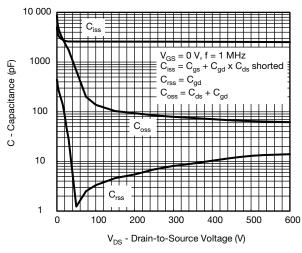


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

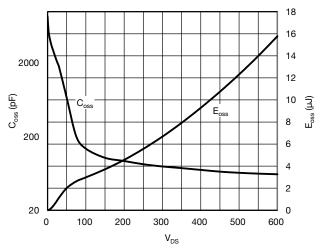


Fig. 6 - Coss and Eoss vs. VDS



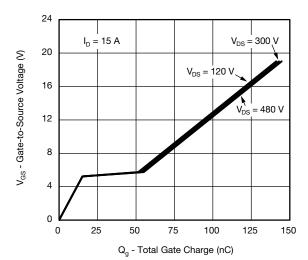


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

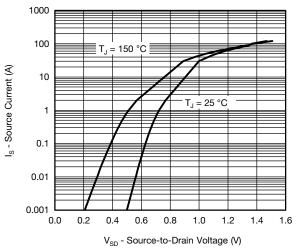


Fig. 8 - Typical Source-Drain Diode Forward Voltage

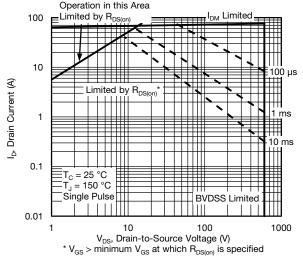


Fig. 9 - Maximum Safe Operating Area

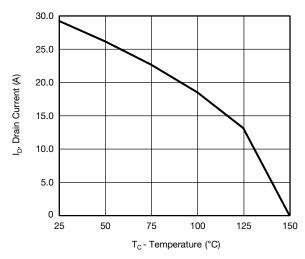


Fig. 10 - Maximum Drain Current vs. Case Temperature

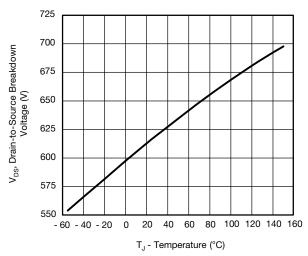
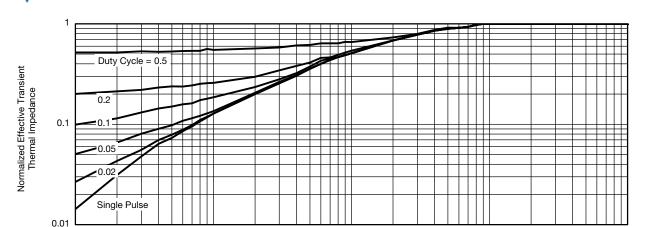
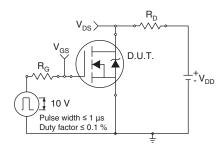


Fig. 11 - Temperature vs. Drain-to-Source Voltage



Square Wave Pulse Duration (s)
Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

0.01



0.001

0.0001

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Fig. 13 - Switching Time Test Circuit

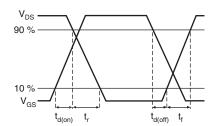


Fig. 14 - Switching Time Waveforms

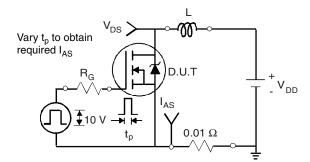
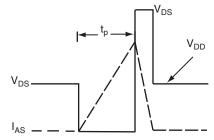


Fig. 15 - Unclamped Inductive Test Circuit



0.1

Fig. 16 - Unclamped Inductive Waveforms

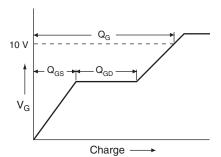


Fig. 17 - Basic Gate Charge Waveform

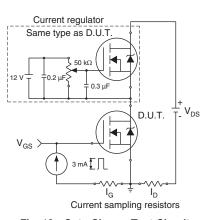
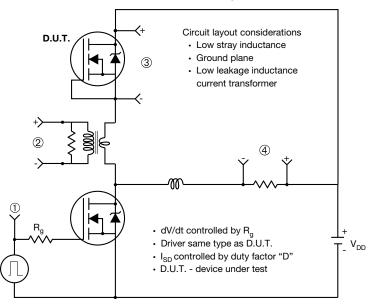


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



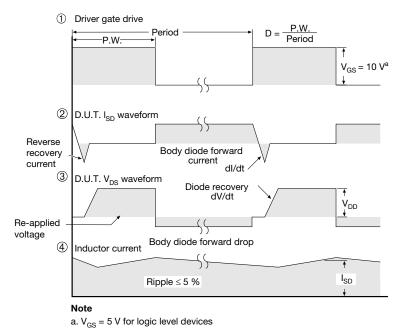


Fig. 19 - For N-Channel

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TO-263AB (HIGH VOLTAGE)







	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.06	4.83	0.160	0.190
A1	0.00	0.25	0.000	0.010
b	0.51	0.99	0.020	0.039
b1	0.51	0.89	0.020	0.035
b2	1.14	1.78	0.045	0.070
b3	1.14	1.73	0.045	0.068
С	0.38	0.74	0.015	0.029
c1	0.38	0.58	0.015	0.023
c2	1.14	1.65	0.045	0.065
D	8.38	9.65	0.330	0.380

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D1	6.86	-	0.270	-
Е	9.65	10.67	0.380	0.420
E1	6.22	-	0.245	ı
е	2.54 BSC		0.100 BSC	
Н	14.61	15.88	0.575	0.625
L	1.78	2.79	0.070	0.110
L1	-	1.65	ı	0.066
L2	-	1.78	-	0.070
L3	0.25 BSC		0.010	BSC
L4	4.78	5.28	0.188	0.208

ECN: S-82110-Rev. A, 15-Sep-08

DWG: 5970

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.

Document Number: 91364 www.vishay.com Revision: 15-Sep-08





RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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